

REV	ECN NO	CONTENT	DATE	ENGINEER
A0		INITIAL RELEASE	/	SGF

Note:

1. Material:

- 1.1 Housing: thermoplastic high temp.UL94V-0; Color: natural.
1.2 Terminal: copper alloy.

2. Finsh:

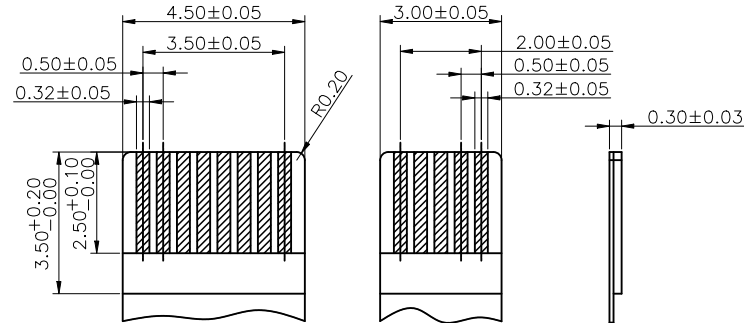
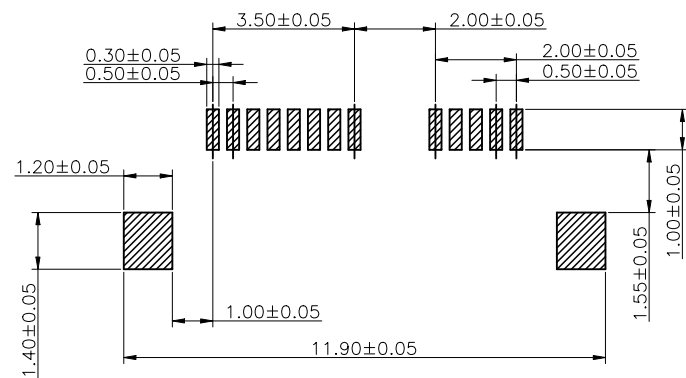
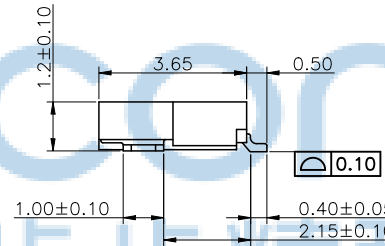
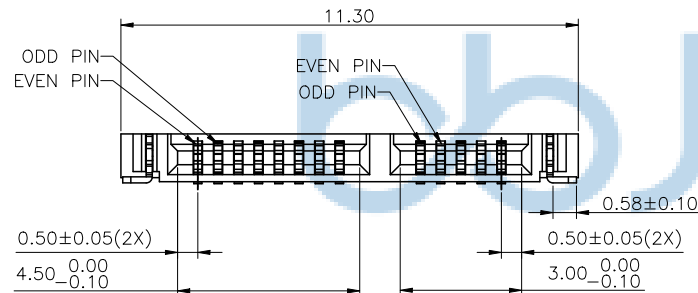
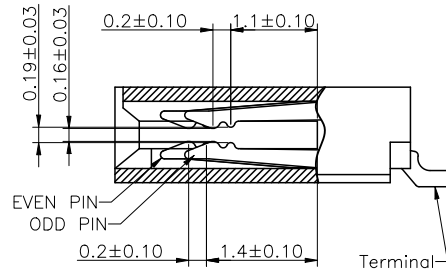
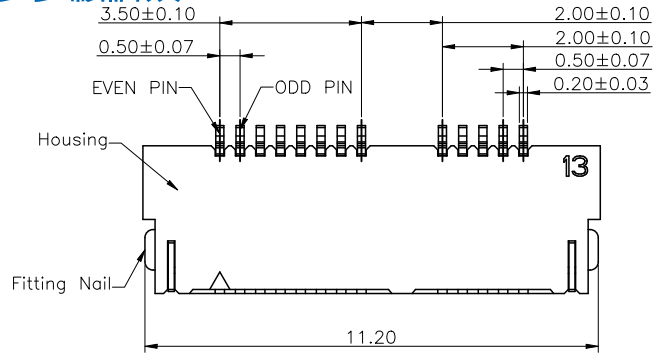
2.1 Terminal:

50~100u" Nickel under plating over all
l:Gold flash on contact and solder area.

2.2 Fitting Nail:

50~100u" Nickel under plating over all
80~150u" Matt-Tin over all.

3. Product must comply HF RoHS specification.



RECOMMENDED P.C.B PATTERN LAYOUT
(TOP VIEW)

RECOMMENDED FPC/FFC DIMENSION
(TOP VIEW)

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PDWG NO: 0407-1



深圳市步步精科技有限公司

.X: ±0.38 .X': ±3"
.XX: ±0.25 .X': ±2"
.XXX: ±0.13 .XX': ±1"

NAME: FPC 0.5-13P 卧贴无盖
8+5P H=1.2 编带(AFC61)

APPD JM_Zheng

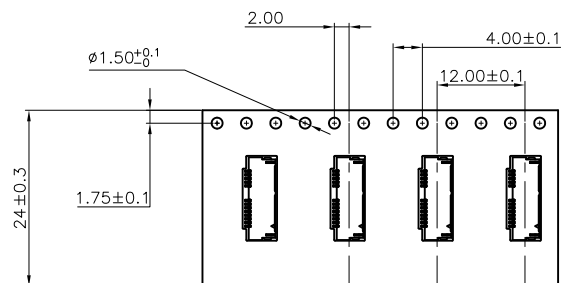
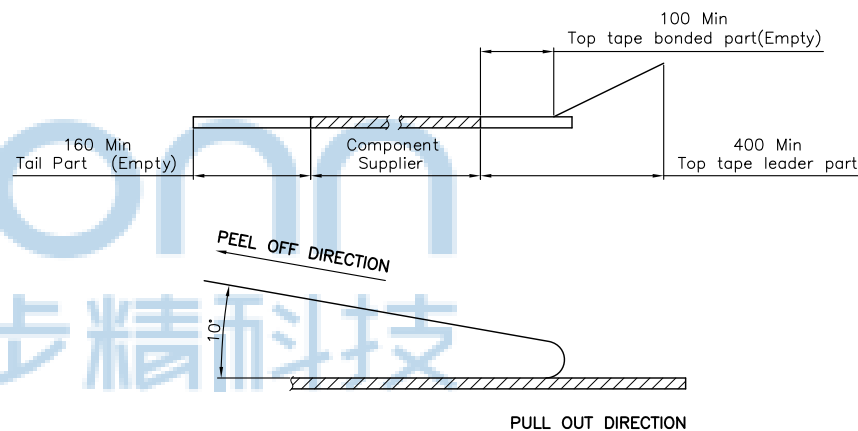
PJ NO: 130-221-130003-W3G

CHKD LYX

SIZE:A4 DRW NO:

DR SGF

FINISH:SEE NOTES MAT'L:SEE NOTES
SCALE:N/A REV:A0 UNIT:mm PAGE:1/2



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.X: ± 0.38 X*: $\pm 3^*$.XX: ± 0.25 X*: $\pm 2^*$.XXX: ± 0.13 .XX*: $\pm 1^*$		NAME: FPC 0.5-13P 卧贴无盖 8+5P H=1.2 编带(AFC61)			
APPD	JM_Zheng		PJ NO: 130-221-130003-W3G		
CHKD	LYX		SIZE:A4 DRW NO:		
DR	SGF	FINISH:SEE NOTES		MAT'L:SEE NOTES	
		SCALE:N/A	REV: A0	UNIT:mm	PAGE: 2/2